











#### SN54HCT14, SN74HCT14

SCLS225G - JULY 1995-REVISED NOVEMBER 2016

## **SNx4HCT14 Hex Schmitt-Trigger Inverters**

## **Features**

- Operating Voltage Range of 4.5 V to 5.5 V
- Outputs Can Drive Up to 10 LSTTL Loads
- Low Power Consumption: 20-µA Maximum I<sub>CC</sub>
- Typical  $t_{pd} = 18 \text{ ns}$
- ±4-mA Output Drive at 5 V
- Maximum Low Input Current of 1 µA Maximum
- Inputs Are TTL-Voltage Compatible

## **Applications**

- **UPS**
- White Goods
- Computer Peripherals
- **Printers**
- **AC Servo Drives**
- **Desktop Computers**

## 3 Description

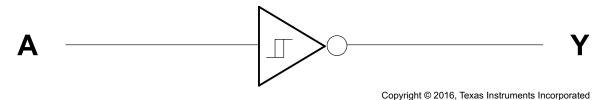
The SNx4HCT14 devices contain six independent inverters. The devices perform the Boolean function Y = A in positive logic.

## Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)    |
|-------------|------------|--------------------|
|             | CFP (14)   | 9.21 mm × 5.97 mm  |
| SN54HCT14   | CDIP (14)  | 19.56 mm × 6.67 mm |
|             | LCCC (20)  | 8.89 mm × 8.89 mm  |
|             | SOIC (14)  | 8.65 mm × 3.91 mm  |
| SN74HCT14   | TVSOP (14) | 3.60 mm × 4.40 mm  |
| SN/4HC114   | PDIP (14)  | 19.30 mm × 6.35 mm |
|             | TSSOP (14) | 5.00 mm × 4.40 mm  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

## **Logic Diagram (Positive Logic)**





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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

## Changes from Revision F (October 2010) to Revision G

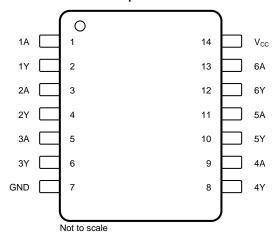
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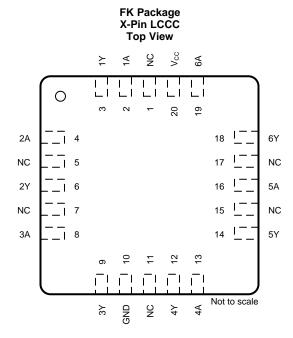
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## 5 Pin Configuration and Functions

D, DB, DGV, J, N, PW, or W Package X-Pin SOIC, SSOP, TVSOP, CDIP, PDIP, TSSOP, or CFP Top View





### **Pin Functions**

|          | PIN  |                     |     |                        |  |  |  |  |
|----------|--|---------------------|-----|------------------------|--|--|--|--|
| NAME     | SOIC, SSOP, TVSOP, CDIP,<br>PDIP, TSSOP, CFP | LCCC                | I/O | DESCRIPTION            |  |  |  |  |
| 1A       | 1  | 2                   | I   | Channel 1 input        |  |  |  |  |
| 1Y       | 2  | 3                   | 0   | Channel 1 output       |  |  |  |  |
| 2A       | 3  | 4                   | I   | Channel 2 input        |  |  |  |  |
| 2Y       | 4  | 6                   | 0   | Channel 2 output       |  |  |  |  |
| 3A       | 5  | 8                   | I   | Channel 3 input        |  |  |  |  |
| 3Y       | 6  | 9                   | 0   | Channel 3 output       |  |  |  |  |
| 4A       | 9  | 13                  | I   | Channel 4 input        |  |  |  |  |
| 4Y       | 8  | 12                  | 0   | Channel 4 output       |  |  |  |  |
| 5A       | 11   | 16                  | I   | Channel 5 input        |  |  |  |  |
| 5Y       | 10   | 14                  | 0   | Channel 5 output       |  |  |  |  |
| 6A       | 13   | 19                  | I   | Channel 6 input        |  |  |  |  |
| 6Y       | 12   | 18                  | 0   | Channel 6 output       |  |  |  |  |
| GND      | 7  | 10                  | _   | Ground                 |  |  |  |  |
| NC       | _  | 1, 5, 7, 11, 15, 17 | _   | No internal connection |  |  |  |  |
| $V_{CC}$ | 14   | 20                  | _   | Power supply           |  |  |  |  |



## 6 Specifications

#### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|   |                             | MIN  | MAX            | UNIT |
|---|-----------------------------|------|----------------|------|
| Supply voltage, V <sub>CC</sub>                   |                             | -0.5 | 7              | V    |
| Input voltage, V <sub>I</sub> <sup>(2)</sup>      |                             | -0.5 | $V_{CC} + 0.5$ | V    |
| Output voltage, V <sub>O</sub> <sup>(2)</sup>     |                             | -0.5 | $V_{CC} + 0.5$ | V    |
| Input clamp current, I <sub>IK</sub>              | $V_I < 0$ or $V_I > V_{CC}$ |      | ±20            | mA   |
| Output clamp current, I <sub>OK</sub>             | $V_O < 0$ or $V_O > V_{CC}$ |      | ±20            | mA   |
| Continuous output current, I <sub>O</sub>         | $V_O = 0$ to $V_{CC}$       |      | ±25            | mA   |
| Continuous current through V <sub>CC</sub> or GND |                             |      | ±50            | mA   |
| Operating junction temperature, T <sub>J</sub>    |                             |      | 150            | °C   |
| Storage temperature, T <sub>stg</sub>             |                             | -65  | 150            | °C   |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

|  |                         |   | VALUE | UNIT |
|--|-------------------------|---|-------|------|
| V <sub>(ESD)</sub> Electrostatic discharge | Clastrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)              | ±2000 |      |
|  | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | ±1000 | V    |

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

## 6.3 Recommended Operating Conditions

see(1)

|          |                                |           | MIN | MAX      | UNIT |
|----------|--------------------------------|-----------|-----|----------|------|
| $V_{CC}$ | Supply voltage                 |           | 4.5 | 5.5      | V    |
| $V_{I}$  | Input voltage                  |           | 0   | $V_{CC}$ | V    |
| Vo       | Output voltage                 |           | 0   | $V_{CC}$ | V    |
| _        |                                | SN54HCT14 | -55 | 125      | 00   |
| IA       | Operating free-air temperature | SN74HCT14 | -40 | 85       | °C   |

<sup>(1)</sup> All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs (SCBA004).

#### 6.4 Thermal Information

|                               |  |             | SN74HCT14    |                |             |               |      |  |
|-------------------------------|--|-------------|--------------|----------------|-------------|---------------|------|--|
| THERMAL METRIC <sup>(1)</sup> |  | D<br>(SOIC) | DB<br>(SSOP) | DGV<br>(TVSOP) | N<br>(PDIP) | PW<br>(TSSOP) | UNIT |  |
|                               |  | 14 PINS     | 14 PINS      | 14 PINS        | 14 PINS     | 14 PINS       |      |  |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 90.9        | 105          | 132.2          | 55.3        | 120.2         | °C/W |  |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 51          | 57           | 51.7           | 42.5        | 48.9          | °C/W |  |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 45.2        | 52.4         | 61.4           | 35.1        | 61.9          | °C/W |  |
| ΨЈТ                           | Junction-to-top characterization parameter   | 18.4        | 22.2         | 5.5            | 27.2        | 5.7           | °C/W |  |
| ΨЈВ                           | Junction-to-board characterization parameter | 44.9        | 51.8         | 60.7           | 35          | 61.3          | °C/W |  |

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

<sup>2)</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



## 6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

|                       | PARAMETER                        | TEST CONDITION   | NS                    | MIN  | TYP   | MAX  | UNIT |
|-----------------------|----------------------------------|--|-----------------------|------|-------|------|------|
|                       |                                  |  | T <sub>A</sub> = 25°C | 1.2  | 1.5   | 1.9  |      |
|                       |                                  | V <sub>CC</sub> = 4.5 V                                  | SN54HCT14             | 1.2  |       | 1.9  |      |
| . ,                   | <b></b>                          |  | SN74HCT14             | 1.2  |       | 1.9  |      |
| $V_{T+}$              | Positive-going threshold         |  | T <sub>A</sub> = 25°C | 1.4  | 1.7   | 2.1  | V    |
|                       |                                  | V <sub>CC</sub> = 5.5 V                                  | SN54HCT14             | 1.4  |       | 2.1  |      |
|                       |                                  |  | SN74HCT14             | 1.4  |       | 2.1  |      |
|                       |                                  |  | T <sub>A</sub> = 25°C | 0.5  | 0.9   | 1.2  |      |
|                       |                                  | V <sub>CC</sub> = 4.5 V                                  | SN54HCT14             | 0.5  |       | 1.2  |      |
|                       |                                  |  | SN74HCT14             | 0.5  |       | 1.2  |      |
| $V_{T-}$              | Negative-going threshold         |  | T <sub>A</sub> = 25°C | 0.6  | 1     | 1.4  | V    |
|                       |                                  | V <sub>CC</sub> = 5.5 V                                  | SN54HCT14             | 0.6  |       | 1.4  |      |
|                       |                                  |  | SN74HCT14             | 0.6  |       | 1.4  |      |
|                       |                                  |  | T <sub>A</sub> = 25°C | 0.4  | 0.6   | 1.4  |      |
|                       |                                  | V <sub>CC</sub> = 4.5 V                                  | SN54HCT14             | 0.4  |       | 1.4  |      |
|                       |                                  |  | SN74HCT14             | 0.4  |       | 1.4  |      |
| $\Delta V_{T}$        | Hysteresis ( $V_{T+} - V_{T-}$ ) | V <sub>CC</sub> = 5.5 V                                  | T <sub>A</sub> = 25°C | 0.4  | 0.65  | 1.5  | V    |
|                       |                                  |  | SN54HCT14             | 0.4  | 0.00  | 1.5  |      |
|                       |                                  |  | SN74HCT14             | 0.4  |       | 1.5  |      |
|                       | High-level output voltage        | $I_{OH}$ = -20 $\mu A$ and $V_{CC}$ = 4.5 $V$            | T <sub>A</sub> = 25°C | 4.4  | 4.49  | 1.0  | _    |
|                       |                                  |  | SN54HCT14             | 4.4  | 7.70  |      |      |
|                       |                                  |  | SN74HCT14             | 4.4  |       |      |      |
| $V_{OH}$              |                                  | $I_{OH}$ = -4 mA and $V_{CC}$ = 4.5 V                    | $T_A = 25^{\circ}C$   | 3.98 | 4.3   |      | V    |
|                       |                                  |  | SN54HCT14             | 3.90 | 4.3   |      | -    |
|                       |                                  |  | SN74HCT14             | 3.84 |       |      |      |
|                       |                                  |  |                       | 3.04 | 0.001 | 0.1  |      |
|                       |                                  | 1 20 vA and V 4.5 V                                      | $T_A = 25^{\circ}C$   |      | 0.001 | 0.1  | V    |
|                       | Low-level output voltage         | $I_{OL}$ = 20 $\mu A$ and $V_{CC}$ = 4.5 $V$             | SN54HCT14             |      |       | 0.1  |      |
| $V_{OL}$              |                                  |  | SN74HCT14             |      | 0.47  | 0.1  |      |
|                       |                                  | 1 4 33 4 33 4 4 5 1/                                     | $T_A = 25^{\circ}C$   |      | 0.17  | 0.26 |      |
|                       |                                  | $I_{OL}$ = 4 mA and $V_{CC}$ = 4.5 V                     | SN54HCT14             |      |       | 0.4  |      |
|                       |                                  |  | SN74HCT14             |      |       | 0.33 |      |
|                       |                                  |  | T <sub>A</sub> = 25°C |      |       | ±0.1 |      |
| l <sub>l</sub>        | Input current                    | $V_I = V_{CC}$ or GND and $V_{CC} = 5.5 \text{ V}$       | SN54HCT14             |      |       | ±1   | μA   |
|                       |                                  |  | SN74HCT14             |      |       | ±1   |      |
|                       |                                  | $V_I = V_{CC}$ or GND, $I_O = 0$ , and                   | T <sub>A</sub> = 25°C |      |       | 2    |      |
| I <sub>CC</sub>       | Supply current                   | V <sub>CC</sub> = 5.5 V                                  | SN54HCT14             |      |       | 40   | μA   |
|                       |                                  |  | SN74HCT14             |      |       | 20   |      |
| . /41                 |                                  | One input at 0.5 V or 2.4 V, other                       | T <sub>A</sub> = 25°C |      | 0.2   | 2.4  |      |
| $\Delta I_{CC}^{(1)}$ | Change in supply current         | inputs at GND or $V_{CC}$ , and $V_{CC} = 5.5 \text{ V}$ | SN54HCT14             |      |       | 3    | mA   |
|                       |                                  | vCC = 3.3 v  | SN74HCT14             |      |       | 2.9  |      |
|                       |                                  |  | $T_A = 25$ °C         |      | 3     | 10   | pF   |
| $C_{i}$               | Input capacitance                | $V_I = V_{CC}$ or GND and $V_{CC} = 5 \text{ V}$         | SN54HCT14             |      |       | 10   |      |
|                       |                                  |  | SN74HCT14             |      |       | 10   |      |

<sup>(1)</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or  $V_{CC}$ .



## 6.6 Switching Characteristics

over recommended operating free-air temperature range and  $C_L = 50 \text{ pF}$  (unless otherwise noted; see Figure 5)

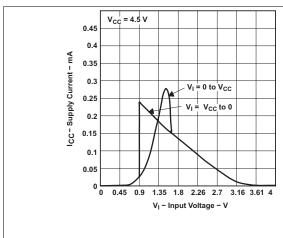
|                 | PARAMETER    | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS          |                       | MIN | TYP | MAX | UNIT |
|-----------------|--------------|-----------------|----------------|--------------------------|-----------------------|-----|-----|-----|------|
|                 |              |                 |                |                          | T <sub>A</sub> = 25°C |     | 20  | 32  |      |
|                 |              |                 |                | $V_{CC} = 4.5 \text{ V}$ | SN54HCT14             |     |     | 48  |      |
| t <sub>pd</sub> | Propagation  | ^               | V              |                          | SN74HCT14             |     |     | 40  |      |
|                 | (delay) time | (delay) time    |                | T <sub>A</sub> = 25°C    |                       | 18  | 30  | ns  |      |
|                 |              |                 |                | V <sub>CC</sub> = 5.5 V  | SN54HCT14             |     |     | 45  |      |
|                 |              |                 |                |                          | SN74HCT14             |     |     | 38  |      |
|                 |              |                 |                |                          | T <sub>A</sub> = 25°C |     | 7   | 15  |      |
|                 |              |                 |                | $V_{CC} = 4.5 \text{ V}$ | SN54HCT14             |     |     | 22  |      |
|                 |              |                 | V              |                          | SN74HCT14             |     |     | 19  |      |
| t <sub>t</sub>  |              | _               | Y              |                          | T <sub>A</sub> = 25°C |     | 6   | 14  | ns   |
|                 |              |                 |                | V <sub>CC</sub> = 5.5 V  | SN54HCT14             |     |     | 20  |      |
|                 |              |                 |                |                          | SN74HCT14             |     |     | 17  |      |

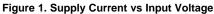
## 6.7 Operating Characteristics

 $T_A = 25^{\circ}C$ 

|                 | PARAMETER                     | TEST CONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|-----------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | No load         | 10  | pF   |

## 6.8 Typical Characteristics





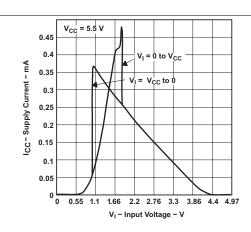
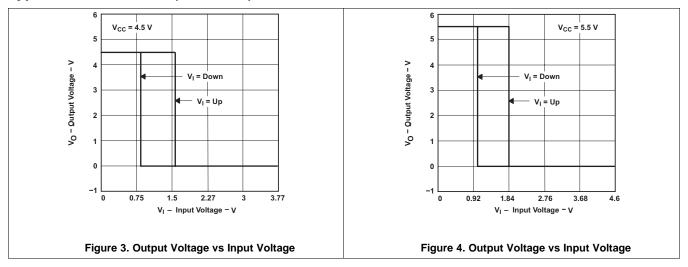


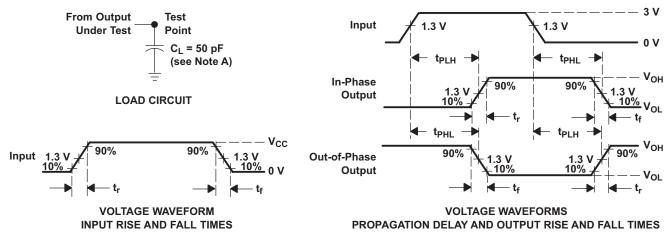
Figure 2. Supply Current vs Input Voltage



## **Typical Characteristics (continued)**



### 7 Parameter Measurement Information



- A. C<sub>1</sub> includes probe and test-fixture capacitance.
- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_f = 6$  ns,  $t_f = 6$  ns.
- C. The outputs are measured one at a time with one input transition per measurement.
- D. t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>.

Figure 5. Load Circuit and Voltage Waveforms



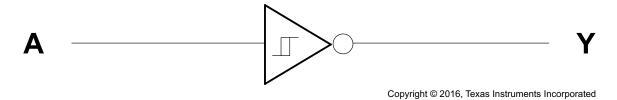
## 8 Detailed Description

#### 8.1 Overview

The SNx4HCT14 Schmitt-Trigger devices contain six independent inverters. They perform the Boolean function  $Y = \overline{A}$  in positive logic.

Schmitt-Trigger inputs are designed to provide a minimum separation between positive and negative switching thresholds. This allows for noisy or slow inputs that would cause problems such as oscillation or excessive current draw with normal CMOS inputs.

## 8.2 Functional Block Diagram



## 8.3 Feature Description

The wide operating range of these devices allow them to be used in a variety of systems that use different logic levels. The outputs can drive up to 10 LSTTL loads each. The balanced drive outputs can source or sink 8 mA at 5-V  $V_{CC}$ . This device is also input TTL compatible.

### 8.4 Device Functional Modes

Table 1 lists the functional modes of the SNx4HCT14.

**Table 1. Function Table** 

| INPUT A | OUTPUT Y |
|---------|----------|
| Н       | L        |
| L       | Н        |

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## 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 9.1 Application Information

The SN74HCT14 device is a Schmitt-Trigger input CMOS device that can be used for a multitude of inverting buffer type functions. The application shown here takes advantage of the Schmitt-Trigger inputs to produce a delay for a logic input.

## 9.2 Typical Application

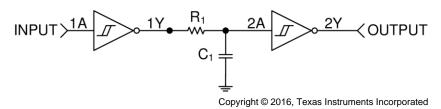


Figure 6. Simplified Application Schematic

#### 9.2.1 Design Requirements

This device uses CMOS technology. Take care to avoid bus contention, because it can drive currents that would exceed maximum limits. Parallel output drive can create fast edges into light loads, so consider routing and load conditions to prevent ringing.

### 9.2.2 Detailed Design Procedure

This circuit is designed around an RC network that produces a slow input to the second inverter. The RC time constant,  $\tau$ , is calculated from:  $\tau = RC$ .

The delay time for this circuit is from  $t_{delay(min)} = -ln |1 - V_{T+(min)}| / V_{CC}| \tau$  to  $t_{delay(max)} = -ln |1 - V_{T+(max)}| / V_{CC}| \tau$ . It must be noted that the delay is consistent for each device, but because the switching threshold is only ensured between the minimum and maximum value, the output pulse length varies between devices. These values must be calculated by using the minimum and maximum ensured  $V_{T+}$  values in the *Electrical Characteristics*.

The resistor value must be chosen such that the maximum current to and from the SN74HCT14 is 8 mA at 5-V  $V_{CC}$ .

# TEXAS INSTRUMENTS

## **Typical Application (continued)**

#### 9.2.3 Application Curve

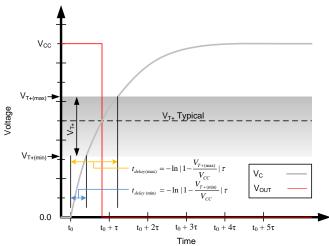


Figure 7. Ideal Capacitor Voltage and Output Voltage With Positive Switching Threshold

## 10 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions*. The  $V_{CC}$  terminal must have a good bypass capacitor to prevent power disturbance. TI recommends using a 0.1- $\mu$ F capacitor on the  $V_{CC}$  terminal, and must be placed as close as possible to the pin for best results.

## 11 Layout

#### 11.1 Layout Guidelines

When using multiple bit logic devices, inputs must never float. In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only three of the four buffer gates are used. Such inputs must not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that must be applied to any particular unused input depends on the function of the device. Generally they are tied to GND or  $V_{CC}$ , whichever makes more sense or is more convenient. Floating outputs are generally acceptable, unless the part is a transceiver.

#### 11.2 Layout Example

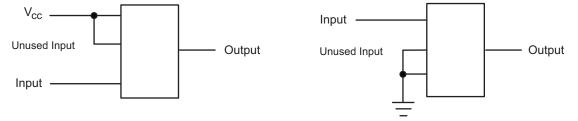


Figure 8. Layout Diagram

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## 12 Device and Documentation Support

## 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

Implications of Slow or Floating CMOS Inputs (SCBA004)

#### 12.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 2. Related Links

| PARTS     | PRODUCT FOLDER | SAMPLE & BUY | TECHNICAL DOCUMENTS | TOOLS &<br>SOFTWARE | SUPPORT & COMMUNITY |
|-----------|----------------|--------------|---------------------|---------------------|---------------------|
| SN54HCT14 | Click here     | Click here   | Click here          | Click here          | Click here          |
| SN74HCT14 | Click here     | Click here   | Click here          | Click here          | Click here          |

## 12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.4 Community Resource

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 12.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

## 12.6 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.





24-Aug-2018

## **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish  | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5)                | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|-------------------|--------------------|--------------|--|---------|
| 5962-86890012A   | ACTIVE | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE        | N / A for Pkg Type | -55 to 125   | 5962-<br>86890012A<br>SNJ54HCT<br>14FK | Samples |
| 5962-8689001CA   | ACTIVE | CDIP         | J                  | 14   | 1              | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 5962-8689001CA<br>SNJ54HCT14J          | Samples |
| 5962-8689001DA   | ACTIVE | CFP          | W                  | 14   | 1              | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 5962-8689001DA<br>SNJ54HCT14W          | Samples |
| SN74HCT14D       | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14DBR     | ACTIVE | SSOP         | DB                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HT14                                   | Samples |
| SN74HCT14DE4     | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14DG4     | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14DGVR    | ACTIVE | TVSOP        | DGV                | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HT14                                   | Samples |
| SN74HCT14DR      | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14DRE4    | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14DRG3    | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU SN             | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14DRG4    | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14DT      | ACTIVE | SOIC         | D                  | 14   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14DTG4    | ACTIVE | SOIC         | D                  | 14   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | HCT14                                  | Samples |
| SN74HCT14N       | ACTIVE | PDIP         | N                  | 14   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | N / A for Pkg Type | -40 to 85    | SN74HCT14N                             | Samples |
| SN74HCT14NE4     | ACTIVE | PDIP         | N                  | 14   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | N / A for Pkg Type | -40 to 85    | SN74HCT14N                             | Samples |



## PACKAGE OPTION ADDENDUM

24-Aug-2018

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish (6) | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5)                   | Samples |
|------------------|------------|--------------|--------------------|------|----------------|----------------------------|----------------------|--------------------|--------------|--|---------|
| SN74HCT14PWR     | ACTIVE     | TSSOP        | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN    | Level-1-260C-UNLIM | -40 to 85    | HT14                                   | Samples |
| SN74HCT14PWRE4   | ACTIVE     | TSSOP        | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | HT14                                   | Samples |
| SN74HCT14PWRG4   | ACTIVE     | TSSOP        | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | HT14                                   | Samples |
| SN74HCT14PWT     | ACTIVE     | TSSOP        | PW                 | 14   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | HT14                                   | Samples |
| SN74HCT14PWTG4   | ACTIVE     | TSSOP        | PW                 | 14   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | HT14                                   | Samples |
| SNJ54HCT14FK     | ACTIVE     | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE           | N / A for Pkg Type | -55 to 125   | 5962-<br>86890012A<br>SNJ54HCT<br>14FK | Samples |
| SNJ54HCT14J      | ACTIVE     | CDIP         | J                  | 14   | 1              | TBD                        | A42                  | N / A for Pkg Type | -55 to 125   | 5962-8689001CA<br>SNJ54HCT14J          | Samples |
| SNJ54HCT14W      | ACTIVE     | CFP          | W                  | 14   | 1              | TBD                        | A42                  | N / A for Pkg Type | -55 to 125   | 5962-8689001DA<br>SNJ54HCT14W          | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



## PACKAGE OPTION ADDENDUM

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54HCT14, SN74HCT14:

Catalog: SN74HCT14

Automotive: SN74HCT14-Q1, SN74HCT14-Q1

Military: SN54HCT14

#### NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military QML certified for Military and Defense Applications

## PACKAGE MATERIALS INFORMATION

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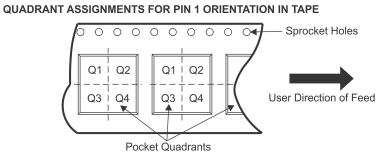
## TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
|    | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

- Reel Width (WT)



### \*All dimensions are nominal

| Device         | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74HCT14DBR   | SSOP            | DB                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 6.6        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74HCT14DGVR  | TVSOP           | DGV                | 14 | 2000 | 330.0                    | 12.4                     | 6.8        | 4.0        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74HCT14DR    | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74HCT14DR    | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74HCT14DR    | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.8                     | 6.5        | 9.5        | 2.3        | 8.0        | 16.0      | Q1               |
| SN74HCT14DRG3  | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.8                     | 6.5        | 9.5        | 2.3        | 8.0        | 16.0      | Q1               |
| SN74HCT14DRG4  | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74HCT14DT    | SOIC            | D                  | 14 | 250  | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74HCT14PWR   | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74HCT14PWR   | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74HCT14PWRG4 | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74HCT14PWT   | TSSOP           | PW                 | 14 | 250  | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |

**PACKAGE MATERIALS INFORMATION** 

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\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74HCT14DBR   | SSOP         | DB              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74HCT14DGVR  | TVSOP        | DGV             | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74HCT14DR    | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| SN74HCT14DR    | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74HCT14DR    | SOIC         | D               | 14   | 2500 | 364.0       | 364.0      | 27.0        |
| SN74HCT14DRG3  | SOIC         | D               | 14   | 2500 | 364.0       | 364.0      | 27.0        |
| SN74HCT14DRG4  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| SN74HCT14DT    | SOIC         | D               | 14   | 250  | 210.0       | 185.0      | 35.0        |
| SN74HCT14PWR   | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74HCT14PWR   | TSSOP        | PW              | 14   | 2000 | 364.0       | 364.0      | 27.0        |
| SN74HCT14PWRG4 | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74HCT14PWT   | TSSOP        | PW              | 14   | 250  | 367.0       | 367.0      | 35.0        |

## W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



## DGV (R-PDSO-G\*\*)

### **24 PINS SHOWN**

### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
   Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
   Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



## D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
  - Sody length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



## PW (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



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